

# IEEE Standard for Low-Rate Wireless Networks

IEEE Computer Society

Developed by the  
LAN/MAN Standards Committee

**IEEE Std 802.15.4™-2020**  
(Revision of IEEE Std 802.15.4-2015)

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# **IEEE Standard for Low-Rate Wireless Networks**

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**LAN/MAN Standards Committee**  
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Approved on 6 May 2020

**IEEE SA Standards Board**

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**Abstract:** The physical layer (PHY) and medium access control (MAC) sublayer specifications for low-data-rate wireless connectivity with fixed, portable, and moving devices with no battery or very limited battery consumption requirements are defined in this standard. In addition, the standard provides modes that allow for precision ranging. PHYs are defined for devices operating in a variety of geographic regions.

**Keywords:** ad hoc network, IEEE 802.15.4™, low data rate, low power, LR-WPAN, mobility, PAN, personal area network, radio frequency, RF, short range, wireless, wireless network, wireless personal area network, WPAN

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**Patrick W. Kinney, Co-Vice Chair**

**James P. K. Gilb, Working Group Technical Editor**

**Patrick W. Kinney, Secretary**

**Gary Stuebing, 802.15.4md Task Group Chair**

**Don Sturek, 802.15.4md Task Group Vice Chair**

**Kunal P. Shah, 802.15.4md Technical Editor**

Hendrik Ahlendorf	Christopher Hett	Michael McInnis
Koorosh Akhavan	Jay Holcomb	Apurva Mody
Bernd Baer	Oliver Holland	Ayman Naguib
David Barras	Iwao Hosako	Jaroslav Niewczas
Tuncer Baykas	Brima Ibrahim	Paul Nikolich
Philip Beecher	Tetsushi Ikegami	Philip Orlik
Friedbert Berens	Yeong Min Jang	Aditya Padaki
Lennert Bober	Seongah Jeong	Glenn Parsons
Monique Brown	Seong-Soon Joe	Charles Perkins
Chris Calvert	Volker Jungnickel	Albert Petrick
Radhakrishna Canchi	Paul Kettle	Joe Pollard
Jaesang Cha	Shoichi Kitazawa	Clinton Powell
Matthew Chang	Tero Kivinen	Demir Rakanovic
Soo-Young Chang	Daniel Knobloch	Ivan Reede
Clint Chaplin	Ryuji Kohno	Joerg Robert
Sangsung Choi	Fumihiko Kojima	Benjamin Rolfe
Boris Danev	Andreas Krieger	Ren Sakata
Luc Darmon	Thomas Kuerner	Ruben E. Salazar Cardozo
Hendricus De Ruijter	Jack Lee	Ioannis Sarris
Brandon Dewberry	Mingyu Lee	Peter Sauer
Anthony Fagan	Frank Leong	Nikola Serafimovski
Matthew Gillmore	Huan-Bang Li	Tushar Shah
Tim Godfrey	Zheda Li	Stephen Shellhammer
Jianlin Guo	Sang-Kyu Lim	Karthik Srinivasagopalan
Joachim Hammerschmidt	Thomas Lorbach	Billy Verso
Shinsuke Hara	Masood Maqbool	Johannes Wechsler
Hiroshi Harada	Vinayagam Mariappan	Brian Weis
Timothy Harrington	Alejandro Marquez	Peter Yee
Chris Hartmann		Shaun Yu

Major contributions in the revision process were received from the following individuals:

Harry Bims	Tero Kivinen	Kunal P. Shah
Hendricus De Ruijter	Clint Powell	Gary Stuebing
Chris Hett	R. K. Rannow	Don Sturek
Roger Hislop	George Robert	Billy Verso
Klaus Hueske	Benjamin Rolfe	Lisa Ward
Shoichi Kitazawa	Ruben E. Salazar Cardozo	Hidetoshi Yokota

The following members of the individual balloting committee voted on this standard. Balloters may have voted for approval, disapproval, or abstention.

Thomas Alexander	Werner Hoelzl	Benjamin Rolfe
David Barras	Brima Ibrahim	Ruben E Salazar Cardozo
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Demetrio Bucaneg, Jr	Stuart Kerry	Kunal Shah
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Boris Danev	Yasushi Kudoh	Mark Sturza
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Anthony Fagan	Zheda Li	Billy Vento
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Many individuals have participated in the IEEE P802.15 Working Group during various stages of the standard's development. Since the initial publication, many amendments have added functionality or updated material in this standard, and now three revisions have been published. Here is a historical list of the working group participants who dedicated their valuable time, energy, and knowledge to the advancement of this standard at the time of its original publication and for its revisions. Many of these members also worked on amendments.

The following members of the IEEE P802.15 Working Group participated in the development of the original standard, IEEE Std 802.15.4-2003:

**Robert F. Heile**, *Chair*  
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**Michael D. McInnis**, *Assistant Secretary and Editor*

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Roberto Aiello  
Masaaki Akahane  
Richard Alfvén  
Arun Arunachalam  
Naiel Askar  
Venkat Balakrishnan  
D. J. Bailey  
Jay Blain  
James Baker  
Vaiganesh Balakrishnan  
Anuj Batra  
Timothy Blaney  
Kenneth Boehike  
Stan Bottoms  
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Chuck Brabenac  
Soo-Young Chang  
Francois Po\_Shin Chin  
Aik Chindapol

Craig Conkling  
Anand Dabak  
Kai Dombrowski  
Mary DuVal  
Michael Dydyk  
Jason L. Ellis  
Mark W. Fidler  
Jeff R. Foerster  
David S. Furuno  
Pierre Gandolfo  
Atul Garg  
James Gilb  
Nada Golmie  
Yasuo Harada  
Allen Heberling  
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Robert Y. Huang  
Eran Iglor  
Katsumi Ishii

Jeyhan Karaoguz  
Masami Katagiri  
Joy H. Kelly  
Stuart J. Kerry  
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Liang Li  
Yeong-Chang Maa  
Steven March  
Ralph Mason  
Jim Meyer  
Leonard E. Miller  
Akira Miura  
Andreas Molisch

Antonio Mondragon  
Tony Morelli  
Chiu Ngo  
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Kazuhisa Takamura  
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Teik-Kheong Tan  
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Ritesh Vishwakarma  
Thierry Walrant  
Jing Wang  
Fijio Watanabe  
Mathew Welborn  
Richard Wilson  
Stephen Wood  
Edward G. Woodrow  
Hirohisa Yamaguchi  
Amos Young  
Song-Lin Young  
Nakache Yves-paul  
Jim Zyren

Major contributions were received from the following individuals:

Tony Adamson  
David Archer  
David Avery  
Venkat Bahl  
Daniel Bailey  
Edul Batliwala  
Pratik Bose  
Boaz Carmeli  
Farron Dacus  
Martin Digon  
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Charles Luebke  
Masahiro Maeda  
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Fred Martin  
Ralph Mason  
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Mark Tilinghast  
Hans Van Leeuwen  
Jacco van Muiswinkel  
Luis Pereira  
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Wim Zwart

The following members of the IEEE P802.15 Working Group participated in the development of the first revision, IEEE Std 802.15.4-2006:

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Takashi Arita  
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Arthur Astrin  
Yasaman Bahreini  
Jay Bain  
Alan Berkema  
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Bill Carney  
Kuor-Hsin Chang  
Jonathon Cheah  
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Sarm-Goo Cho  
Sungsoo Choi  
Yun Choi  
Chun-Ting Chou  
Manoj Choudhary  
Celestino Corral  
Joe Decuir  
Javier Del Prado Pavon  
Kai Dombrowski  
Stefan Drude  
Amal Ekbal  
Jason Ellis  
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Paul Everest  
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Ian Gifford  
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Sorin Goldenberg  
Vivek Gupta  
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Robert Hall  
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Jeff Harris  
Allen Heberling  
Eric Heinze  
Barry Herold  
Keisuke Higuchi  
Jin-Meng Ho  
Patrick Houghton  
Robert Huang

Tian-Wei Huang  
Hideto Ikeda  
Tetsushi Ikegami  
Adrian Jennings  
Ho-In Jeon  
Tzyy Hong Jiang  
David Julian  
Jeyhan Karaoguz  
Michael Kelly  
Stuart Kerry  
Jae-Hyon Kim  
Jaeyoung Kim  
Jinkyong Kim  
Yongsuk Kim  
Kursat Kimyacioglu  
Matthias Kindler  
Guenter Kleindl  
Ryuji Kohno  
Mike Krell  
Yasushi Kudo  
Akiomi Kunisa  
Yuzo Kuramochi  
Jiun-You Lai  
Ismail Lakkis  
John Lampe  
Kyung Kuk Lee  
Wooyong Lee  
David Leeper  
Huan-Bang Li  
Haixiang Liang  
Ian Macnamara  
Akira Maeki  
Patricia Martigne  
Abbie Mathew  
Taisuke Matsumoto  
Gustaf Max  
Michael McLaughlin  
Charlie Mellone  
Klaus Meyer  
Samuel Mo  
Andreas Molisch  
Mark Moore  
Ken Naganuma  
Yves-Paul Nakache  
Hiroyuki Nakase  
Saishankar Nandagopalan  
Chiu Ngo  
Erwin Noble  
John O'Conor  
Knut Odman  
Hiroyo Ogawa  
Yasuyuki Okuma

Philip Orlik  
Laurent Ouvry  
John Pardee  
Nirmalendu Patra  
Dave Patton  
Xiaoming Peng  
Tony Pollock  
Vidyasagar Premkumar  
Yihong Qi  
Raad Raad  
Pekka Ranta  
Dani Raphaeli  
Gregg Rasor  
Charles Razzell  
Ivan Reede  
Yuko Rikuta  
Terry Robar  
Glyn Roberts  
Richard Roberts  
Benjamin A. Rolfe  
Philippe Rouzet  
Chandos Rypinski  
Ali Sadri  
Saeid Safavi  
Zafer Sahinoglu  
Tomoki Saito  
Syed Saleem  
Kamran Sayrafian  
Jean Schwoerer  
Erik Schylander  
Alireza Seyedi  
Sanjeev Sharma  
Siddharth Shetty  
John Shi  
Shusaku Shimada  
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William Shvodian  
Thomas Siep  
Michael Sim  
Kazimierz Siwiak  
V. Somayazulu  
Amjad Soomro  
Carl Stevenson  
Kazuaki Takahashi  
Kenichi Takizawa  
Teik-Kheong Tan  
Mike Tanahashi  
Yasushi Tanaka  
James Taylor  
Arnaud Tonnerre  
Ichihiko Toyoda

Jerry Upton  
Bart Van Poucke  
Chris Weber  
Matthew Welborn  
Magnus Wiklund

Gerald Wineinger  
Patrick Worfolk  
Tracy Wright  
Hirohisa Yamaguchi  
Kamya Yekeh Yazdandoost

Su-Khiong Yong  
Zhan Yu  
Serdar Yurdakul  
Mahmoud Zadeh  
Bin Zhen

Major contributions in the revision process were received from the following individuals:

Jon Adams  
Helmut P. Adamski  
Jonathan Avey  
Jon Beniston  
Bernd Grohmann  
José A. Gutierrez  
Jesper Holm  
ZhiJian Hu  
Phil A. Jamieson  
Yuen-Sam Kwok

Colin Lanzl  
Myung Lee  
Zhongding Lei  
Liang Li  
Yong Liu  
Frederick Martin  
Frank Poegel  
Matthias Scheide  
D. C. Seward

Huai-Rong Shao  
Mark Shea  
Stephen J. Shellhammer  
Mark A. Tillinghast  
Johannes Van Leeuwen  
Richard Wilson  
Ping Xiong  
Bing Xu  
ChenYang Yang  
Chunhui Zhu

The following members of the IEEE P802.15 Working Group participated in the development of the second revision, IEEE Std 802.15.4-2011:

**Robert F. Heile, Chair**  
**Rick Alfvín, Co-Vice Chair**  
**Patrick W. Kinney, Co-Vice Chair**  
**James P. K. Gilb, Working Group Technical Editor**  
**Patrick W. Kinney, Secretary**

**James P. K. Gilb, Task Group 4i Chair and Technical Editor**

Emad Afifi  
Gahng-Seop Ahn  
Roberto Aiello  
Arthur Astrin  
Taehan Bae  
Michael Bahr  
John Barr  
Anuj Batra  
Tuncer Baykas  
Philip E. Beecher  
Ashutosh Bhatia  
Ghulam Bhatti  
Gary Birk  
Mathew Boytim  
Peter David Bradley  
Nancy Bravin  
David Britz  
Monique B. Brown  
Sverre Brubk  
Brian Buchanan  
John Buffington  
Kiran Bynam  
Brent Cain  
Edgar H. Callaway  
Chris Calvert

Ruben E. Salazar Cardozo  
Douglas Castor  
Jaesang Cha  
Russell Chandler  
Kuor-Hsin Chang  
Soo-Young Chang  
Clint Chaplin  
Hind Chebbo  
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Sangsung Choi  
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Mark Dawkins  
Hendricus de Ruijter  
Upkar Dhaliwal  
Gang Ding  
Paul Dixon  
Guido Dolmans  
Igor Dotlic  
Michael Dow  
Dietmar Eggert  
David Evans  
Charles Farlow

John Farserotu  
Jeffrey Fischbeck  
Mike Fischer  
George Flammer  
Ryosuke Fujiwara  
Noriyasu Fukatsu  
Kiyoshi Fukui  
John Geiger  
Gregory Gillooly  
Tim Godfrey  
Paul Gorday  
Elad Gottlib  
Robert Hall  
Shinsuke Hara  
Hiroshi Harada  
Timothy Harrington  
Rodney Hemminger  
Marco Hernandez  
Garth Hillman  
Jin-Meng Ho  
Wei Hong  
Srinath Hosur  
David Howard  
Jung-Hwan Hwang  
Taeho Hwang

Ichirou Ida  
Tetsushi Ikegami  
Akio Iso  
Yeong Min Jang  
Adrian Jennings  
Wuncheol Jeong  
Steven Jillings  
Noh-Gyoung Kang  
Tae-Gyu Kang  
Shuzo Kato  
Tatsuya Kato  
Jeritt Kent  
Prithpal Khakuria  
Dae Ho Kim  
Dong-Sun Kim  
Dukhyun Kim  
Jaehwan Kim  
Jeffrey King  
Ryuji Kohno  
Fumihide Kojima  
Bruce Kraemer  
Raymond Krasinski  
Masahiro Kuroda  
John Lampe  
Zhou Lan  
Khanh Le  
Cheolhyo Lee  
Hyungsoo Lee  
Myung Lee  
Daniel Lewis  
Huan-Bang Li  
Liang Li  
Sang-Kyu Lim  
Jeremy Link  
Mike Lynch  
Robert Mason  
Tomokuni Matsumura  
Jeff McCullough  
Michael McGillan  
Michael D. McInnis  
Michael McLaughlin  
Charles Millet  
Siamak Mirnezami  
Rishi Mohindra  
Emmanuel Monnerie  
Rajendra Moorti

Robert Moskowitz  
Hamilton Moy  
Peter Murray  
Theodore Myers  
Chiu Ngo  
Paul Nikolich  
Hirohito Nishiyama  
David Olson  
Okundu Omeni  
Ryoji Ono  
Laurent Ouvry  
James Pace  
Hyung-Il Park  
Jahng Park  
Seung-Hoon Park  
Taejoon Park  
Ranjeet Patro  
Al Petrick  
Dalibor Pokrajac  
Daniel Popa  
Stephen Pope  
Clinton C. Powell  
Richard Powell  
Chang-Woo Pyo  
Mohammad Rahman  
Sridhar Rajagopal  
Jayaram Ramasastry  
Marc Reed  
Ivan Reede  
Richard Roberts  
Craig Rodine  
June Chul Roh  
Benjamin A. Rolfe  
Seung-Moon Ryu  
Didier Sagan  
Kentaro Sakamoto  
Will San Filippo  
H. Sanderford  
Kamran Sayrafian  
Timothy Schmidl  
Michael Schmidt  
Jean Schwoerer  
Cristina Seibert  
Neal Seidl  
Kunal Shah

Steve Shearer  
Stephen Shellhammer  
Shusaku Shimada  
Chang Sub Shin  
Cheol Ho Shin  
Michael Sim  
Jonathan Simon  
Jaeseung Son  
Paul Stadnik  
René Struik  
Chin-Sean Sum  
Hui-Hsia Sung  
Gu Sungi  
Kenichi Takizawa  
Hirokazu Tanaka  
Larry Taylor  
Mark Thompson  
James Tomcik  
Ichihiko Toyoda  
David Tracey  
Khanh Tran  
Jerry Upton  
Jana van Greunen  
Hartman van Wyk  
Michel Veillette  
Billy Verso  
Bhupender Virk  
Joachim Walewski  
Junyi Wang  
Quan Wang  
Xiang Wang  
Andy Ward  
Scott Weikel  
Nicholas West  
Mark Wilbur  
Ludwig Winkel  
Eun Tae Won  
Alan Chi Wai Wong  
Tao Xing  
Wen-Bin Yang  
Yang Yang  
Kazuyuki Yasukawa  
Kamya Yazdandoost  
Kaoru Yokoo  
Mu Zhao  
Bin Zhen

Major contributions in the revision process were received from the following individuals:

Philip E. Beecher  
Vern Brethour  
Monique B. Brown  
Edgar H. Callaway  
Kuor-Hsin Chang

Clint Chaplin  
James P. K. Gilb  
Patrick W. Kinney  
Michael D. McInnis

Clinton C. Powell  
Benjamin A. Rolfe  
Timothy Schmidl  
René Struik  
Billy Verso

The following members of the IEEE P802.15 Working Group participated in the development of the second revision, IEEE Std 802.15.4-2015:

**Robert F. Heile, Chair**

**Rick Alvin, Co-Vice Chair**

**Patrick W. Kinney, Co-Vice Chair**

**James P. K. Gilb, Working Group Technical Editor**

**Patrick W. Kinney, Secretary**

**Patrick W. Kinney, 802.15 Maintenance Committee Chair**

**Benjamin A. Rolfe, 802.15 Maintenance Committee Vice Chair**

**James P. K. Gilb, Technical Editor**

Mounir Achir	Shinsuke Hara	Robert Moskowitz
Keiji Akiyama	Timothy Harrington	Jinesh P. Nair
Arthur Astrin	James Hartman	Chiu Ngo
Philip Beecher	Marco Hernandez	Paul Nikolich
Frederik Beer	Ken Hiraga	John Notor
Chandrashekhar P. S. Bhat	Iwao Hosako	Hiroyo Ogawa
Kiran Bynam	Yeong Min Jang	Taejoon Park
Edgar Callaway	Seong-Soon Joo	Glenn Parsons
Chris Calvert	Akifumi Kasamatsu	Charles Perkins
Radhakrishna Canchi	Shuzo Kato	Albert Petrick
Kapseok Chang	Toyoyuki Kato	Clinton C. Powell
Soo-Young Chang	Jeritt Kent	Verotiana Rabarijaona
Clint Chaplin	Jaehwan Kim	Ivan Reede
Stephen Chasko	Youngsoo Kim	Richard Roberts
Paul Chilton	Shoichi Kitazawa	Ruben E. Salazar Car-
Sangsung Choi	Tero Kivinen	dozo
Hendricus de Ruijter	Ryuji Kohno	Noriyuki Sato
Guido Dolmans	Fumihide Kojima	Norihiko Sekine
Igor Dotlic	Thomas Kuerner	Kunal Shah
Stefan Drude	Byung-Jae Kwak	Stephen Shellhammer
Dietmar Eggert	Jae Seung Lee	Shusaku Shimada
Shahriar Emami	Myung Lee	Gary Stuebing
Andrew Estrada	Sangjae Lee	Don Sturek
David Evans	Huan-Bang Li	Mineo Takai
George Flammer	Liang Li	Kou Togashi
Kiyoshi Fukui	Qing Li	Billy Verso
Matthew Gillmore	Michael Lynch	Gabriel Villardi
Tim Godfrey	Itaru Maekawa	Brian Weis
Elad Gottlib	Hiroyuki Matsumura	Makoto Yaita
Jussi Haapola	Michael McLaughlin	Peter Yee
Rainer Hach	Michael McInnis	Yu Zeng
	Kenichi Mori	Chunhui (Allan) Zhu

Major contributions in the revision process were received from the following individuals:

Philip Beecher	Jeritt Kent	Benjamin A. Rolfe
Monique Brown	Patrick W. Kinney	Ruben E. Salazar Cardozo
Edgar Callaway	Tero Kivinen	Cristina Seibert
Soo-Young Chang	Amarjeet Kumar	Kunal Shal
James P. K. Gilb	Michael McInnis	Shusakh Shimada
Tim Godfrey	Robert Moskowitz	Chin-Sean Sum
Jussi Haapola	Clinton C. Powell	Larry Taylor
Timothy Harrington	Verotiana Rabarijaona	Billy Verso

## Introduction

This introduction is not part of IEEE Std 802.15.4-2020, IEEE Standard for Low-Rate Wireless Networks.

This is the fourth revision of IEEE Std 802.15.4. From the beginning, the goal of the IEEE P802.15 Working Group was to produce a standard that enabled very low-cost, low-power communications. The initial standard, IEEE Std 802.15.4-2003, defined two optional physical layers (PHYs), operating in different frequency bands with a simple and effective medium access control (MAC).

In 2006, the standard was revised and added two more PHY options. The MAC remained backward compatible, but the revision added MAC frames with an increased version number and a variety of MAC enhancements, including the following:

- Support for a shared time base with a data timestamping mechanism
- Support for beacon scheduling
- Synchronization of broadcast messages in beacon-enabled personal area networks (PANs)
- Improved MAC layer security

In 2011, the standard was revised to include the three amendments approved subsequent to the 2006 revision. This effort added four more PHY options along with the MAC capability to support ranging. Additionally, the organization of the standard was changed so that each PHY would have a separate clause, and the MAC clause was split into functional description, interface specification, and security specification.

The 2015 revision of the standard was created to roll in the amendments approved subsequent to the 2011 revision: six PHY amendments and one MAC amendment, with corrigenda and clarifications. The features added by the amendments include the following:

- Enhanced frame formats maintaining backward compatibility
- Information Elements (IEs)
- Channel agility
- Extended superframe options
- Low-energy mechanisms
- An enhanced acknowledgment frame that can carry data and can be secured
- Prioritized channel access
- A variety of new PHY modulation, coding, and band options to support a wide variety of application needs including radio frequency identification (RFID), smart utility networks (SUNs), television white space (TVWS) operation, low-energy critical infrastructure monitoring (LECIM), and rail communications and control (RCC)

Much of the corrigenda and clarifications were collected from requests from individuals after the revision in 2011. Major corrigenda items included changes to the security text to correct errors and clarify the text, removal of the encrypt only mode, addition of security policy checks for the IEs, corrections regarding personal area network identifier (PAN ID) compression behavior to eliminate ambiguous specification, and changes to the IEs subclauses to include more information necessary for users of this standard.

The Project Authorization Request (PAR) for IEEE Std 802.15.4-2015 was first proposed in July 2013 and was approved in October 2013 by IEEE's New Standards Committee (NesCom). After three working group ballots and two IEEE SA Committee ballots, the final standard was approved in December 2015, just over two years from start to finish.

The current revision of the standard was revised to include six approved amendments subsequent to the 2015 revision. This effort added two more PHY amendments and one MAC amendment, with corrigenda and clarifications. The features added by the amendments include the following:

- A variety of new PHY modulation, coding, and band options to support a wide variety of application needs including smart utility networks (SUNs), china medical band (CMB), ternary amplitude shift keying (TASK) and rate switch Gaussian frequency shift keying (RS-GFSK)

Much of the corrigenda and clarifications were collected from requests from individuals after the revision in 2015. Major corrigenda items included changes to the transmission order of the address field.

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# IEEE Standard for Low-Rate Wireless Networks

## 1. Overview

### 1.1 Scope

This standard defines the physical layer (PHY) and medium access control (MAC) sublayer specifications for low-data-rate wireless connectivity with fixed, portable, and moving devices with no battery or very limited battery consumption requirements. In addition, the standard provides modes that allow for precision ranging. PHYs are defined for devices operating in a variety of geographic regions.

### 1.2 Purpose

The standard provides for ultra low complexity, ultra low cost, ultra low power consumption, and low data rate wireless connectivity among inexpensive devices, especially targeting the communications requirements of what is now commonly referred to as the Internet of Things. In addition, some of the alternate PHYs provide precision ranging capability that is accurate to one meter. Multiple PHYs are defined to support a variety of frequency bands.